DRAWING DESCRIPTION— PTC R@25C:82 DHMS +/-10%
PTC:.7%/C
DPERATING RANGE:-55 TO 100 C
STORAGE RANGE:-65 TO 150 C
*THERMAL TIME CONSTANT:30 SEC. MAX.
*DISSIPATION CONSTANT:2.5 mW/C MIN.
POWER RATING:.25W@25 C,DERATE TO 100 SOLDERING RECOMMENDATIONS: DEVICE IS NOT SUITABLE FOR MOUNTING ON FLEXIBLE SUBSTRATES OR WHERE LOADS ARE PLACED ON THE TERMINATION. FIG. *As tested per MIL-R-23648. vary dependent on mounting MAXIMUM TEMPERATURE DIFFERENCE BETWEEN SOLVENT FOR IMMERSION AND THERMISTOR SHALL BE 150 C MAXIMUM TEMPERATURE DIFFERENCE BETWEEN SOLDER AND THERMISTOR SHALL BE 150 C HAND SOLDERING IS NOT RECCOMENDED, HOWEVER IF NEEDED SOLDERING IRON TIP SHALL NOT EXCEED 250 C RECOMMENDED REFLOW PEAK=220 TO PERFORMANCE CHARACTERISTICS SOLDER RECOMMENDATIONS 10 SECUNDS MAX NUMBER- QT0805-820K TO 100 Μαγ $\langle | \rangle$ | | ∞ N(C) TEMP IG 175N011 0500 15 050 LO ---RESISTANCE MULTIPLIER \tag{\tau} < < \tag{\tau} < \tag{\tau} 77 |-|-- - - - 875 50000 8780000 CHARCTERISTICS \mathcal{D} (/) 070 - .086 \supset \supset ×. RESISTANCE TOLERANCE 04 NB00047 FIG. -026 ū \supset H DIMENSIONS (INCHES) R N N N % POWER T T U $\mathop{\textstyle \bigcirc}_{\textstyle >}$ \square 00 Z . <u>.</u> ω POWER DERATING TEMPERATURE W) T D **(/)** 100 (C) CURVE \leq 055MAX Ĭ ∐